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High Speed Infrared Emitting Diode, RoHS Compliant, 890 nm, GaAlAs Double Hetero

TSMF1000 TSMF1020





TSMF1030



16758-5

DESCRIPTION

TSMF1000 series are infrared, 890 nm emitting diodes in GaAlAs double hetero (DH) technology with high radiant power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

FEATURES

- Package type: surface mount
- Package form: GW, RGW, yoke, axial
- Dimensions (L x W x H in mm): 2.5 x 2 x 2.7
- Peak wavelength: λ_p = 890 nm
- · High radiant power
- Angle of half intensity: $\varphi = \pm 17^{\circ}$
- Low forward voltage
- Suitable for high pulse current operation
- · Versatile terminal configurations
- Package matches with detector TEMD1000
- Floor life: 168 h, MSL 3, acc. J-STD-020
- Compliant to RoHS Directive 2002/95/EC and in accordance with WEEE 2002/96/EC

APPLICATIONS

- IrDA compatible data transmission
- Miniature light barrier
- Photointerrupters
- Optical switch
- · Control and drive circuits
- · Shaft encoders

PRODUCT SUMMARY				
COMPONENT	I _e (mW/sr)	φ (deg)	λ _P (nm)	t _r (ns)
TSMF1000	5	± 17	890	30
TSMF1020	5	± 17	890	30
TSMF1030	5	± 17	890	30

Note

· Test conditions see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
TSMF1000	Tape and reel	MOQ: 1000 pcs, 1000 pcs/reel	Reverse gullwing		
TSMF1020	Tape and reel	MOQ: 1000 pcs, 1000 pcs/reel	Gullwing		
TSMF1030	Tape and reel	MOQ: 1000 pcs, 1000 pcs/reel	Yoke		

Note

• MOQ: minimum order quantity



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ABSOLUTE MAXIMUM RA	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V _R	5	V
Forward current		I _F	100	mA
Peak forward current	$t_p/T = 0.5, t_p = 100 \mu s$	I _{FM}	200	mA
Surge forward current	t _p = 100 μs	I _{FSM}	0.8	Α
Power dissipation		P _V	180	mW
Junction temperature		T _j	100	°C
Operating temperature range		T _{amb}	- 40 to + 85	°C
Storage temperature range		T _{stg}	- 40 to + 100	°C
Soldering temperature	t ≤ 5 s	T _{sd}	260	°C
Thermal resistance junction/ambient	Soldered on PCB, pad dimensions: 4 mm x 4 mm	R _{thJA}	400	K/W

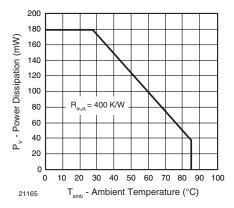


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

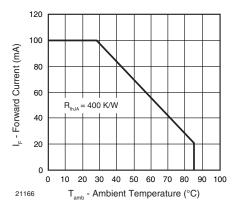


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Famuurd valtaga	I _F = 20 mA	V _F		1.3	1.5	V
Forward voltage	$I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$	V _F		2.4		V
Temperature coefficient of V _F	I _F = 1 mA	TK _{VF}		- 1.8		mV/K
Reverse current	V _R = 5 V	I _R			10	μA
Junction capacitance	$V_R = 0 V, f = 1 MHz, E = 0$	Cj		160		pF
Dedicat intensity	I _F = 20 mA	l _e	2.5	5	13	mW/sr
Radiant intensity	$I_F = 100 \text{ mA}, t_p = 100 \mu \text{s}$	l _e		25		mW/sr
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	фе		35		mW
Temperature coefficient of ϕ_e	I _F = 20 mA	TKφ _e		- 0.6		%/K
Angle of half intensity		φ		± 17		deg
Peak wavelength	I _F = 20 mA	λ_p		890		nm
Spectral bandwidth	I _F = 20 mA	Δλ		40		nm
Temperature coefficient of λ _p	I _F = 20 mA	TKλ _p		0.2		nm/K
Rise time	I _F = 20 mA	t _r		30		ns
Fall time	I _F = 20 mA	t _f		30		ns
Cut-off frequency	I _{DC} = 70 mA, I _{AC} = 30 mA pp	f _c		12		MHz
Virtual source diameter		d		1.2		mm

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BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

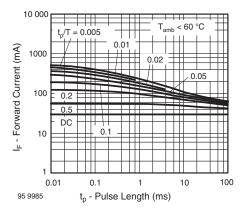


Fig. 3 - Pulse Forward Current vs. Pulse Duration

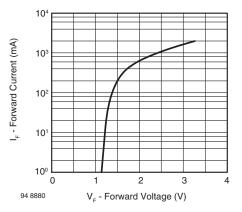


Fig. 4 - Forward Current vs. Forward Voltage

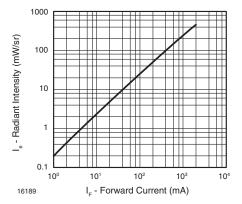


Fig. 5 - Radiant Intensity vs. Forward Current

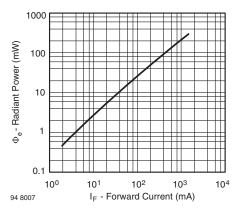


Fig. 6 - Radiant Power vs. Forward Current

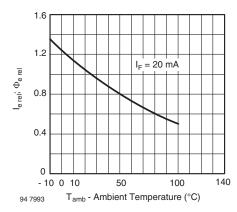


Fig. 7 - Rel. Radiant Intensity/Power vs. Ambient Temperature

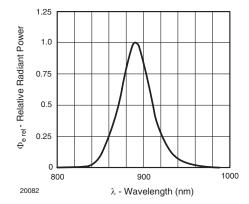


Fig. 8 - Relative Radiant Power vs. Wavelength



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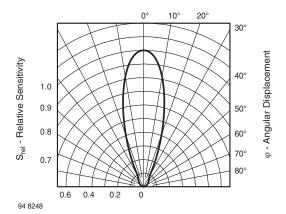


Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

PRECAUTIONS FOR USE

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (burn out will happen).

2. Storage

- Storage temperature and rel. humidity conditions are: 5 °C to 35 °C, R.H. 60 %.
- Floor life must not exceed 168 h, acc. to JEDEC level 3, J-STD-020.
 - Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp proof box with desiccant.
 - Considering tape life, we suggest to use products within one year from production date.
- If opened more than one week in an atmosphere 5 °C to 35 °C, R.H. 60 %, devices should be treated at 60 °C ± 5 °C for 15 h.
- If humidity indicator in the package shows pink color (normal blue), then devices should be treated with the same conditions as 2.3.

REFLOW SOLDER PROFILE

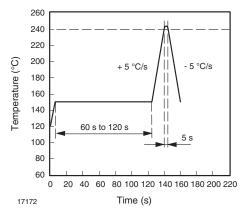
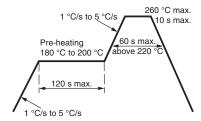


Fig. 10 - Lead Tin (SnPb) Reflow Solder Profile



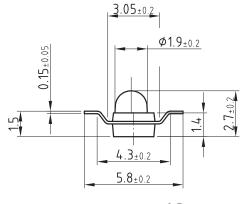
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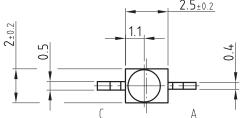
Fig. 11 - Lead (Pb)-Free Reflow Solder Profile acc. J-STD-020



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PACKAGE DIMENSIONS in millimeters: TSMF1000





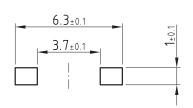
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Issue: 3; 02.04.03

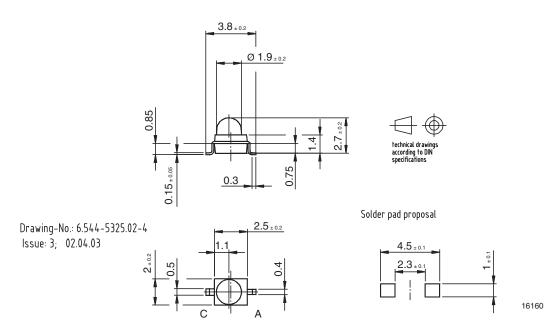
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technical drawings according to DIN specifications

Solder pad proposal



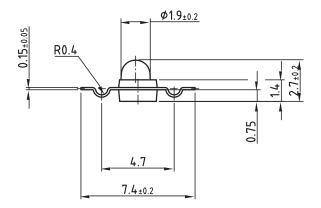
PACKAGE DIMENSIONS in millimeters: TSMF1020





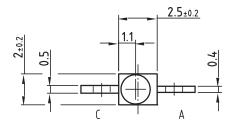
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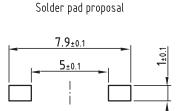
PACKAGE DIMENSIONS in millimeters: TSMF1030



Drawing-No.: 6.544-5329.01-4 Issue: 4; 08.05.03

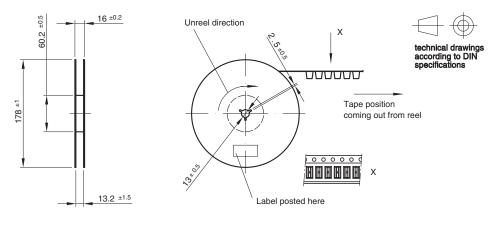




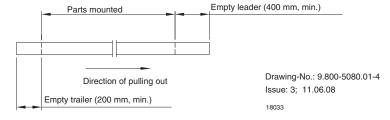


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REEL DIMENSIONS in millimeters



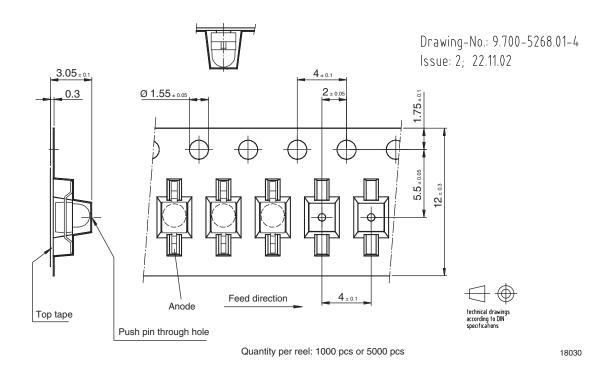
Leader and trailer tape:



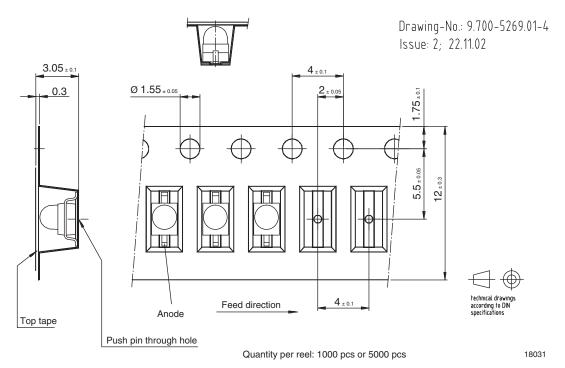


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TAPING DIMENSIONS in millimeters: **TSMF1000**



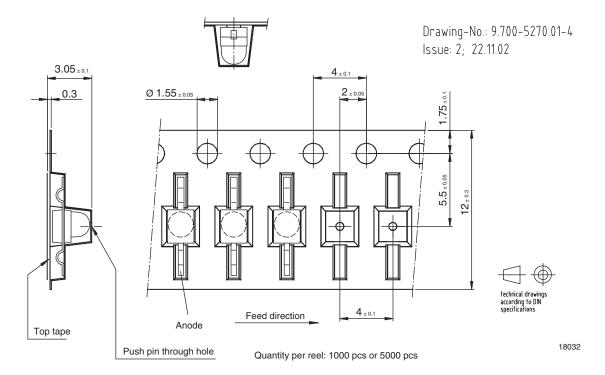
TAPING DIMENSIONS in millimeters: **TSMF1020**





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TAPING DIMENSIONS in millimeters: TSMF1030



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